## XP05554

## Silicon NPN epitaxial planer transistor

### For high speed switching

## Features

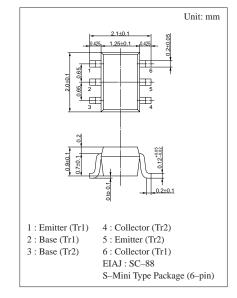
- For high speed switching.
- Low collector to emitter saturation voltage V<sub>CE(sat)</sub>.
- Two elements incorporated into one package.

#### Basic Part Number of Element

•  $2SC3757 \times 2$  elements

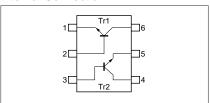
### Absolute Maximum Ratings (Ta=25°C)

Parameter		Symbol	Ratings	Unit	
Rating of element	Collector to base voltage	$V_{CBO}$	40	V	
	Collector to emitter voltage	$V_{CES}$	40	V	
	Emitter to base voltage	$V_{EBO}$	5	V	
	Collector current	$I_{\rm C}$	100	mA	
	Peak collector current	$I_{CP}$	300	mA	
Overall	Total power dissipation	$P_{T}$	150	mW	
	Junction temperature	$T_j$	150	°C	
	Storage temperature	$T_{stg}$	-55 to +150	°C	



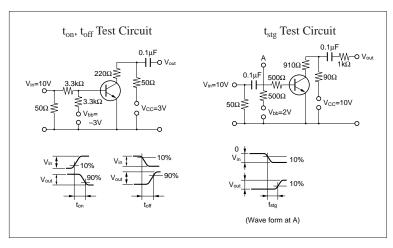
## Marking Symbol: HE

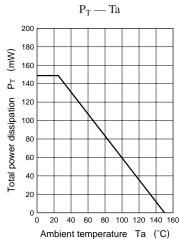
#### Internal Connection

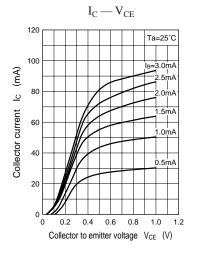


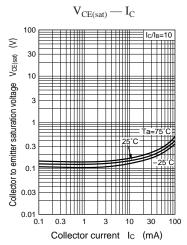
## Electrical Characteristics (Ta=25°C)

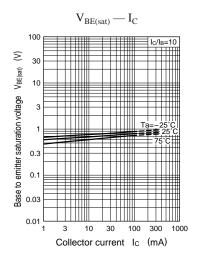
Parameter	Symbol	Conditions	min	typ	max	Unit
Collector cutoff current	$I_{CBO}$	$V_{CB} = 15V, I_E = 0$			0.1	μΑ
Emitter cutoff current	$I_{EBO}$	$V_{EB} = 4V, I_C = 0$			0.1	μΑ
Forward current transfer ratio	$h_{FE}$	$V_{CE} = 1V$ , $I_C = 10mA$	90		200	
Collector to emitter saturation voltage	V <sub>CE(sat)</sub>	$I_C = 10\text{mA}, I_B = 1\text{mA}$		0.17	0.25	V
Base to emitter saturation voltage	V <sub>BE(sat)</sub>	$I_{C} = 10\text{mA}, I_{B} = 1\text{mA}$			1.0	V
Transition frequency	$f_T$	$V_{CB} = 10V, I_E = -10mA, f = 200MHz$		450		MHz
Collector output capacitance	C <sub>ob</sub>	$V_{CB} = 10V, I_E = 0, f = 1MHz$		2	6	pF
Turn-on time	t <sub>on</sub>			17		ns
Turn-off time	t <sub>off</sub>			17		ns
Storage time	t <sub>stg</sub>			10		ns

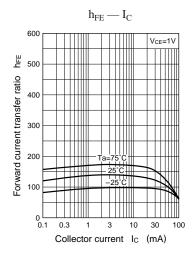


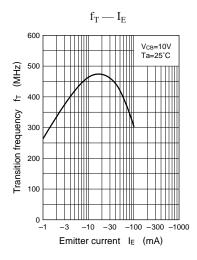


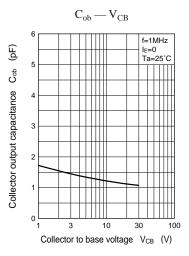












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